onsemi

IGBT – **Power, Co-PAK** N-Channel, Field Stop VII (FS7), SCR, Power TO247-3L, 1200 V, 1.4 V, 100 A

FGY100T120RWD

Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 3–lead package, FGY100T120RWD offers the optimum performance with low conduction losses and good switching controllability for a high efficiency operation in various applications like motor control, UPS, data center and high–power switch.

Features

- Low Conduction Loss and Optimized Switching
- Maximum Junction Temperature $T_J = 175^{\circ}C$
- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- 100% of the Parts are Dynamically Tested
- Short Circuit Rated
- RoHS Compliant

Applications

- Motor Control
- UPS
- General Application Requiring High Power Switch

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter		Symbol	Value	Unit
Collector-to-Emitter Voltage		V _{CES}	1200	V
Gate-to-Emitter Voltage	V _{GES}	±20		
Transient Gate-to-Emitter	Voltage		±30	
Collector Current	T _C = 25°C	Ι _C	200	А
	T _C = 100°C		100	
Power Dissipation	$T_C = 25^{\circ}C$	PD	1071	W
	T _C = 100°C		535	
Pulsed Collector Current	T _C = 25°C, t _p = 10 μs (Note 1)	I _{CM}	300	A
Diode Forward	T _C = 25°C	١ _F	200	
Current	T _C = 100°C		100	
Pulsed Diode Forward Current	T _C = 25°C, t _p = 10 μs (Note 1)	I _{FM}	300	
Short Circuit Withstand Time $V_{GE} = 15 \text{ V}, V_{CC} = 600 \text{ V}, T_{C} = 150^{\circ}\text{C}$		T _{SC}	5	μs
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 175	°C
Lead Temperature for Solo	ΤL	260		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

BV _{CES}	V _{CE(SAT)}	I _C
1200 V	1.4 V	100 A

PIN CONNECTIONS





TO247-3LD CASE 340CD

MARKING DIAGRAM



- = 3-Digit Date Code
 - = 2-Digit Lot Traceability Code
- FGY100T120RWD = Specific Device Code

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ORDERING INFORMATION

Device	Package	Shipping
FGY100T120RWD	TO247–3LD (Pb–Free)	30 Units / Tube

1. Repetitive rating: pulse width limited by max. Junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Max Value	Unit
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.14	°C/W
Thermal Resistance, Junction-to-Case for Diode		0.23	
Thermal Resistance, Junction-to-Ambient	R _{θJA}	40	

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-to-Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 5 mA	1200	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{CES}} / \Delta \text{T}_{\text{J}}$	V _{GE} = 0 V, I _C = 5 mA	-	1221	-	mV/°C
Collector-to-Emitter Cut-Off Current	I _{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	-	-	40	μΑ
Gate-to-Emitter Leakage Current	I _{GES}	V_{GE} = 20 V, V_{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
Gate-to-Emitter Threshold Voltage	V _{GE(TH)}	V_{GE} = V_{CE} , I_C = 100 mA	4.9	5.92	6.7	V
Collector-to-Emitter Saturation	V _{CE(SAT)}	V_{GE} = 15 V, I _C = 100 A, T _J = 25°C	1.15	1.43	1.75	V
voitage		V_{GE} = 15 V, I _C = 100 A, T _J = 175°C	-	1.66	-	
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{IES}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	12200	-	pF
Output Capacitance	C _{OES}		-	392	-	
Reverse Transfer Capacitance	C _{RES}		-	44.2	-	
Total Gate Charge	Q _G	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	427	-	nC
Gate to Emitter Charge	Q _{GE}	I _C = 100 A	-	108	-	
Gate to Collector Charge	Q _{GC}		-	161	-	
SWITCHING CHARACTERISTIC, II	NDUCTIVE LOAI	ס				
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	74	-	ns
Turn-Off Delay Time	t _{d(off)}	$I_{\rm C} = 50$ A, $R_{\rm G} = 4.7 \Omega$, $T_{\rm J} = 25^{\circ}{\rm C}$	-	464	-	
Rise Time	t _r		-	45	-	1
Fall Time	t _f		-	196	-	
Turn-On Switching Loss	E _{on}		-	3.43	-	mJ
Turn–Off Switching Loss	E _{off}		-	4.54	-	1
Total Switching Loss	E _{ts}		-	7.97	-	
Turn-On Delay Time	t _{d(on)}	$\label{eq:VCE} \begin{array}{l} V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V}, \\ I_{C} = 100 \text{ A}, $	-	80	-	ns
Turn-Off Delay Time	t _{d(off)}		-	364	-	
Rise Time	t _r		-	85	-	
Fall Time	t _f		-	180	-	
Turn-On Switching Loss	E _{on}		-	8.13	-	mJ
Turn–Off Switching Loss	E _{off}		-	7.05	-	
Total Switching Loss	E _{ts}		_	15.18	-	

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = 25°C unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTIC, INDUCTIVE LOAD						
Turn-On Delay Time	t _{d(on)}	$\begin{array}{l} V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V}, \\ I_{C} = 50 \text{ A}, $	-	70	-	ns
Turn-Off Delay Time	t _{d(off)}		-	536	-	
Rise Time	t _r		-	50	-	
Fall Time	t _f		-	348	-	
Turn-On Switching Loss	Eon		-	5.58	-	mJ
Turn-Off Switching Loss	E _{off}		-	6.83	-	
Total Switching Loss	E _{ts}		-	12.41	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, \text{ V}_{GE} = 15 \text{ V},$	-	78	-	ns
Turn-Off Delay Time	t _{d(off)}	I _C = 100 A, R _G = 4.7 Ω, T _J = 175°C	-	412	-	
Rise Time	t _r		-	93	-	
Fall Time	t _f		-	316	-	
Turn-On Switching Loss	Eon		-	12.00	-	mJ
Turn–Off Switching Loss	E _{off}		-	10.30	-	
Total Switching Loss	E _{ts}		-	22.30	-	
DIODE CHARACTERISTIC						
Diode Forward Voltage	V _F	I _F = 100 A, T _J = 25°C	1.46	1.80	2.08	V
		I _F = 100 A, T _J = 175°C	-	1.90	-	
DIODE SWITCHING CHARACTER	ISTIC, INDUCTI\	/E LOAD				
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 50 \text{ A},$	-	256	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs, T _J = 25°C	-	3140	-	nC
Reverse Recovery Energy	E _{rec}		-	1	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	24.5	-	А
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 100 \text{ A},$	-	347	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs, T _{.1} = 25°C	-	4408	-	nC
Reverse Recovery Energy	E _{rec}		-	2	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	25.8	-	А
Reverse Recovery Time	t _{rr}	$V_{R} = 600 V, I_{F} = 50 A,$ $dI_{F}/dt = 500 A/\mu s,$ $T_{J} = 175^{\circ}C$	-	424	-	ns
Reverse Recovery Charge	Q _{rr}		-	8610	-	nC
Reverse Recovery Energy	E _{rec}		-	4	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	40.8	-	А
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 100 \text{ A},$	-	572	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs, T _J = 175°C	-	12476	-	nC
Reverse Recovery Energy	E _{rec}]	-	5	-	mJ
Peak Reverse Recovery Current	I _{RRM}	1	-	43.6	-	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)



TYPICAL CHARACTERISTICS (CONTINUED)



Figure 13. Turn-On Time vs Collector Current



Figure 15. Switching Loss vs Collector Current



Figure 17. Diode Reverse Recovery Current



Figure 14. Turn-Off Time vs Collector Current



Figure 16. Diode Forward Characteristics



Figure 18. Diode Reverse Recovery Time

TYPICAL CHARACTERISTICS (CONTINUED)



Figure 19. Diode Stored Charge Characteristics













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